

# FSDM0465RE, FSDM0565RE, FSDM07652RE Green Mode Fairchild Power Switch (FPS<sup>™</sup>)

## Features

- Internal Avalanche-Rugged SenseFET
- Advanced Burst-Mode Operation Consumes Under 1W at 240V<sub>AC</sub> & 0.5W load
- Precision Fixed Operating Frequency (66kHz)
- Internal Start-up Circuit
- Improved Pulse-by-Pulse Current Limiting
- Over-Voltage Protection (OVP)
- Overload Protection (OLP)
- Internal Thermal Shutdown Function (TSD)
- Auto-Restart Mode
- Under-Voltage Lockout (UVLO) with hysteresis
- Low Operating Current (2.5mA)
- Built-in Soft-Start

## Applications

- SMPS for LCD monitor and STB
- Adaptor

## Description

The FSDM0465RE, FSDM0565RE and FSDM07652RE are an integrated Pulse Width Modulator (PWM) and SenseFET specifically designed for high-performance offline Switch Mode Power Supplies (SMPS) with minimal external components. This device is an integrated high-voltage power-switching regulator that combines an avalanche-rugged SenseFET with a current mode PWM control block. The PWM controller includes an integrated fixed-frequency oscillator, undervoltage lockout, leading-edge blanking (LEB), optimized gate driver, internal soft-start, temperature-compensated precise-current sources for a loop compensation, and self-protection circuitry. Compared with a discrete MOSFET and PWM controller solution, it can reduce total cost; component count, size, and weight; while simultaneously increasing efficiency, productivity, and system reliability. This device is a basic platform well suited for cost-effective designs of flyback converters.

## **Ordering Information**

Product Number	Package	Marking Code	BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max.
FSDM0465REWDTU <sup>(1)</sup>	TO-220F-6L (Forming)	DM0465RE	650V	2.6 Ω
FSDM0565REWDTU	TO-220F-6L (Forming)	DM0565RE	650V	2.2 Ω
FSDM0565REIWDTU	I2-PAK-6L (Forming)	DM0565RE	650V	2.2 Ω
FSDM07652REWDTU	TO-220F-6L (Forming)	DM07652RE	650V	1.6 Ω

#### Note:

1. WDTU: Forming Type.

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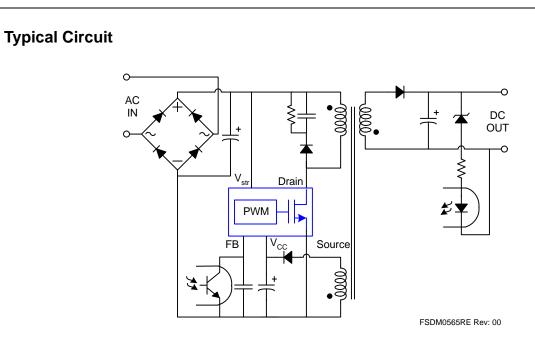


Figure 1. Typical Flyback Application

## **Output Power Table**

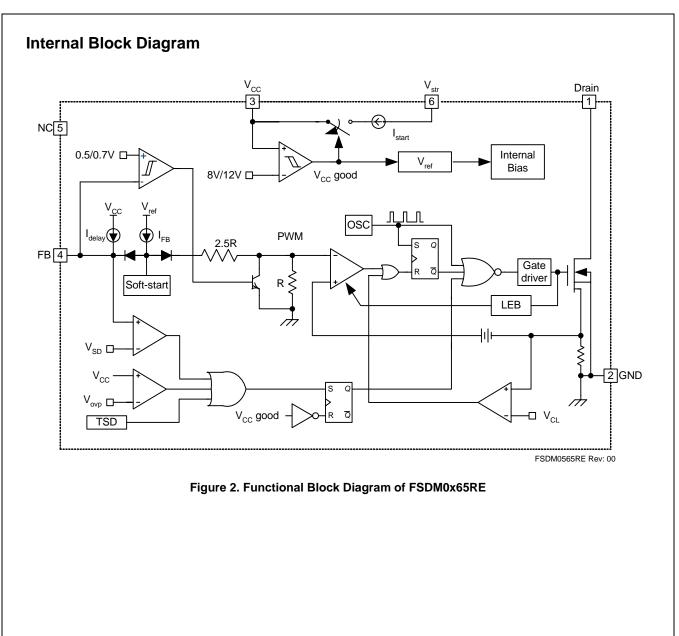
Product	230V <sub>AC</sub> ±15% <sup>(4)</sup>		85–265V <sub>AC</sub>	
Froduct	Adapter <sup>(2)</sup>	Open Frame <sup>(3)</sup>	Adapter <sup>(2)</sup>	Open Frame <sup>(3)</sup>
FSDM0465RE	48W	56W	40W	48W
FSDM0565RE	60W	70W	50W	60W
FSDM0565REI	60W	70W	50W	60W
FSDM07652RE	70W	80W	60W	70W

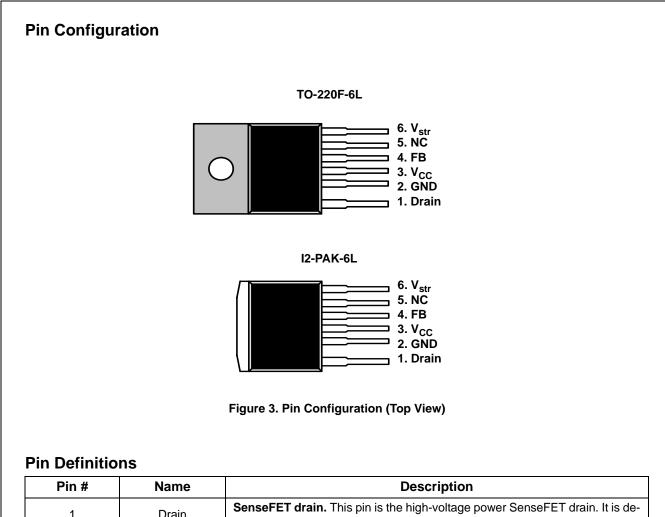
### Notes:

2. Typical continuous power in a non-ventilated enclosed adapter measured at 50°C ambient.

3. Maximum practical continuous power in an open-frame design at 50°C ambient.

4. 230V\_{AC} or 100/115V\_{AC} with doubler.





1	Drain	<b>SenseFET drain.</b> This pin is the high-voltage power SenseFET drain. It is designed to drive the transformer directly.
2	GND	Ground. This pin is the control ground and the SenseFET source.
3	V <sub>CC</sub>	<b>Power Supply.</b> This pin is the positive supply voltage input. During start-up, the power is supplied by an internal high-voltage current source connected to the $V_{str}$ pin. When $V_{CC}$ reaches 12V, the internal high-voltage current source is disabled and the power is supplied from the auxiliary transformer winding.
4	FB	<b>Feedback.</b> This pin is internally connected to the inverting input of the PWM comparator. The collector of an opto-coupler is typically tied to this pin. For stable operation, a capacitor should be placed between this pin and GND. If the voltage of this pin reaches 6.0V, the overload protection is activated, resulting in shutdown of the FPS <sup>™</sup> .
5	NC	No Connection.
6	V <sub>str</sub>	<b>Start-up.</b> This pin is connected directly to the high-voltage DC link. At start-up, the internal high-voltage current source supplies internal bias and charges the external capacitor connected to the V <sub>CC</sub> pin. Once V <sub>CC</sub> reaches 12V, the internal current source is disabled.

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## **Absolute Maximum Ratings**

The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings.  $T_A = 25^{\circ}$ C, unless otherwise specified.

Symbol	Pa	Parameter			Unit
BV <sub>DSS</sub>	Drain Source Breakdown	Voltage		650	V
V <sub>str</sub>	Max. Voltage at Vstart pin			650	V
		FSDM0465RE	T <sub>C</sub> =25°C	9.6	
I <sub>DM</sub>	Drain Current Pulsed <sup>(5)</sup>	FSDM0565RE	T <sub>C</sub> =25°C	11	A <sub>DC</sub>
		FSDM07652RE	T <sub>C</sub> =25°C	15	
		FSDM0465RE	T <sub>C</sub> =25°C	2.2	
		FSDIVI0405RE	T <sub>C</sub> =100°C	1.4	
I	Continuous Drain Current		T <sub>C</sub> =25°C	2.8	А
Ι <sub>D</sub>		FSDIVIUSUSRE	T <sub>C</sub> =100°C	1.7	A
		FSDM07652RE	T <sub>C</sub> =25°C	3.8	
	T ODWOT 0021		T <sub>C</sub> =100°C	2.4	
			FSDM0465RE		
E <sub>AS</sub>	Single Pulsed Avalanche I	Energy <sup>(6)</sup>	FSDM0565RE	190	mJ
	FSDM07652R			370	
V <sub>CC</sub>	Supply Voltage			20	V
V <sub>FB</sub>	Input Voltage Range			-0.3 to V <sub>CC</sub>	V
P <sub>D</sub> (Watt H/S)	Total Power Dissipation (1		TO-220-6L	45	W
r <sub>D</sub> (waii n/S)		C=23 C)	I2-PAK-6L	75	VV
TJ	Operating Junction Tempe	erature		Internally limited	°C
T <sub>A</sub>	Operating Ambient Tempe	erature		-25 to +85	°C
T <sub>STG</sub>	Storage Temperature			-55 to +150	°C
	ESD Capability, HBM Model (All pins except V <sub>str</sub> and FB)			2.0 (GND-V <sub>str</sub> /V <sub>FB</sub> =1.5kV)	kV
	ESD Capability, Machine I (All pins except V <sub>str</sub> and F			300 (GND-V <sub>str</sub> /V <sub>FB</sub> =225V)	V

#### Notes:

5. Repetitive rating: Pulse width limited by maximum junction temperature.

6. L=14mH, starting T<sub>J</sub>=25°C.

## **Thermal Impedance**

 $T_A=25^{\circ}C$ , unless otherwise specified.

Symbol	Parameter	Package	Value	Unit	
θ <sub>.JA</sub> (7)	Junction-to-Ambient Thermal Resistance	TO-220F-6L	49.90	°C/W	
Unction-to-Amble		I2-PAK-6L	30	C/W	
θ <sub>JC</sub> <sup>(8)</sup>	Junction-to-Case Thermal Resistance	TO-220F-6L	2.78	°C/W	
OIC, Junch		I2-PAK-6L	1.67	0/10	

#### Notes:

7. Free-standing, with no heat-sink, under natural convection.

8. Infinite cooling condition - refer to the SEMI G30-88.

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## **Electrical Characteristics**

 $T_A = 25^{\circ}C$  unless otherwise specified.

Symbol	Parame	ter	Condition	Min.	Тур.	Max.	Unit
SenseFET	SECTION				L		
			$V_{DS} = 650V, V_{GS} = 0V$			250	
		FSDM0465RE	$V_{DS} = 520V, V_{GS} = 0V, T_{C} = 125^{\circ}C$			250	
	Zero Gate Voltage		$V_{DS} = 650V, V_{GS} = 0V$			500	
I <sub>DSS</sub>	Drain Current	FSDM0565RE	$V_{DS} = 520V, V_{GS} = 0V, T_{C} = 125^{\circ}C$			500	μA
			$V_{DS} = 650V, V_{GS} = 0V$			500	
		FSDM07652RE	$V_{DS} = 520V, V_{GS} = 0V, T_{C} = 125^{\circ}C$			500	
		FSDM0465RE			2.20	2.60	
R <sub>DS(ON)</sub>	Static Drain Source on Resistance <sup>(9)</sup>	FSDM0565RE	V <sub>GS</sub> = 10V, I <sub>D</sub> = 2.5A		1.76	2.20	Ω
		FSDM07652RE			1.40	1.60	
		FSDM0465RE			60		
C <sub>OSS</sub>	Output Capacitance	FSDM0565RE	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$	25V, f = 1MHz 78	78		pF
		FSDM07652RE			100		
		FSDM0465RE			23		
t <sub>d(on)</sub>	Turn-On Delay Time	FSDM0565RE	V <sub>DD</sub> = 325V, I <sub>D</sub> = 5A		22		nsec
		FSDM07652RE			22		
		FSDM0465RE			20		
t <sub>r</sub>	Rise Time	FSDM0565RE	V <sub>DD</sub> = 325V, I <sub>D</sub> = 5A		52		nsec
		FSDM07652RE			60		
		FSDM0465RE			65		
t <sub>d(off)</sub>	Turn-Off Delay Time	FSDM0565RE	$V_{DD} = 325V, I_D = 5A$		95		nsec
		FSDM07652RE			115		
		FSDM0465RE			27		
t <sub>f</sub>	Fall Time	FSDM0565RE	$V_{DD} = 325V, I_D = 5A$		50		nsec
		FSDM07652RE			65		
CONTROL	SECTION						
fosc	Switching Frequency		V <sub>FB</sub> = 3V	60	66	72	kHz
$\Delta f_{STABLE}$	Switching Frequency		$13V \leq V_{CC} \leq 18V$	0	1	3	%
$\Delta f_{OSC}$	Switching Frequency	Variation <sup>(10)</sup>	$-25^{\circ}C \leq T_A \leq 85^{\circ}C$	0	±5	±10	%
I <sub>FB</sub>	Feedback Source Cur	rent	V <sub>FB</sub> = GND	0.7	0.9	1.1	mA
		FSDM0465RE		77	82	87	%
$D_{MAX}$	Maximum Duty Cycle	FSDM0565RE		77	82	87	%
		FSDM07652RE		75	80	85	%
D <sub>MIN</sub>	Minimum Duty Cycle					0	%
V <sub>START</sub>	UVLO Threshold Volta		V <sub>FB</sub> = GND	11	12	13	V
V <sub>STOP</sub>			V <sub>FB</sub> = GND	7	8	9	V
t <sub>S/S</sub>	Internal Soft-Start Tim	e	V <sub>FB</sub> = 3		10	15	msec

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## Electrical Characteristics (Continued)

 $T_A = 25^{\circ}C$  unless otherwise specified.

Symbol	Parameter		Condition	Min.	Тур.	Max.	Unit
BURST MO	DDE SECTION						
V <sub>BURH</sub>	Rurat Mada Valtagaa		$V_{CC} = 14V$		0.7		V
V <sub>BURL</sub>	Burst Mode Voltages		V <sub>CC</sub> = 14V		0.5		V
PROTECT	ION SECTION						•
V <sub>SD</sub>	Shutdown Feedback Vol	tage	$V_{FB} \ge 5.5V$	5.5	6.0	6.5	V
IDELAY	Shutdown Delay Current		V <sub>FB</sub> = 5V	2.8	3.5	4.2	μA
t <sub>LEB</sub>	Leading-Edge Blanking	Time			250		nsec
		FSDM0465RE	V <sub>FB</sub> = 5V, V <sub>CC</sub> = 14V	1.60	1.80	2.00	
I <sub>LIMIT</sub>	Peak Current Limit <sup>(11)</sup>	FSDM0565RE	V <sub>FB</sub> = 5V, V <sub>CC</sub> = 14V	2.00	2.25	2.50	Α
		FSDM07652RE	V <sub>FB</sub> = 5V, V <sub>CC</sub> = 14V	2.20	2.50	2.70	
V <sub>OVP</sub>	Over-Voltage Protection			18	19	20	V
T <sub>SD</sub>	Thermal Shutdown Tem	perature <sup>(10)</sup>		130	145	160	°C
TOTAL DE	VICE SECTION						•
I <sub>OP</sub>			$V_{FB} = GND, V_{CC} = 14V$				
I <sub>OP(MIN)</sub>	Operating Supply Currer	nt <sup>(12)</sup>	$V_{FB} = GND, V_{CC} = 10V$		2.5	5.0	mA
I <sub>OP(MAX)</sub>			V <sub>FB</sub> = GND, V <sub>CC</sub> = 18V				

Notes:

9. Pulse test: Pulse width  $\leq 300 \mu S,$  duty cycle  $\leq 2\%.$ 

10. These parameters, although guaranteed at the design, are not tested in production.

11. These parameters indicate the inductor current.

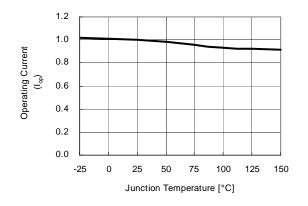
12. This parameter is the current flowing into the control IC.

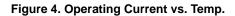
## Comparison Between FS6M07652RTC and FSDM0x65RE

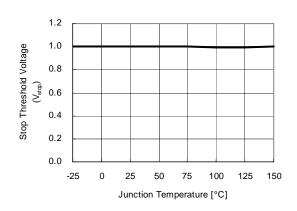
Function	FS6M07652RTC	FSDM0x65RE	FSDM0x65RE Advantages
Soft-Start	Adjustable soft-start time using an external capacitor	Internal soft-start with typically 10ms (fixed)	<ul> <li>Gradually increasing current limit during soft-start reduces peak current and volt- age component stresses</li> <li>Eliminates external soft-start components in most applications</li> <li>Reduces or eliminates output overshoot</li> </ul>
Burst-Mode Operation	<ul> <li>Built into controller</li> <li>Output voltage drops to around half</li> </ul>		<ul> <li>Improves light-load efficiency</li> <li>Reduces no-load consumption</li> </ul>

## **Typical Performance Characteristics**

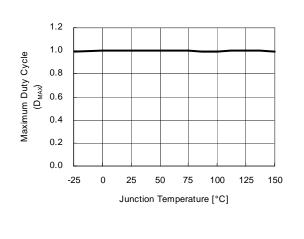
These characteristic graphs are normalized at  $T_A$ = 25°C.













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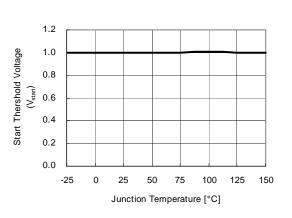


Figure 5. Start Threshold Voltage vs. Temp.

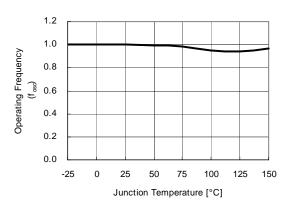
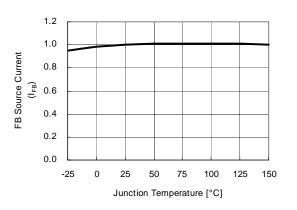


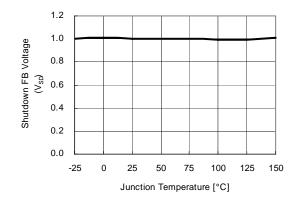
Figure 7. Operating Frequency vs. Temp.

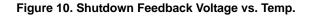




## Typical Performance Characteristics (Continued)

These characteristic graphs are normalized at  $T_A$ = 25°C.





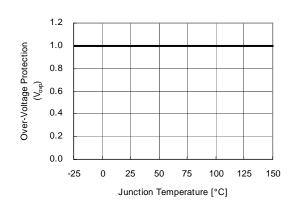


Figure 12. Over-Voltage Protection vs. Temp.

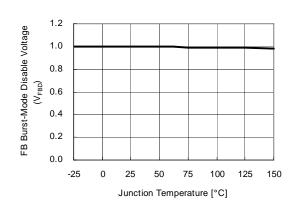


Figure 14. Burst-Mode Disable Voltage vs. Temp.

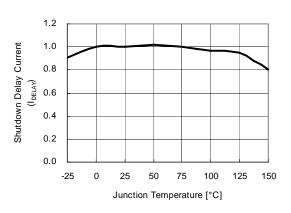


Figure 11. Shutdown Delay Current vs. Temp.

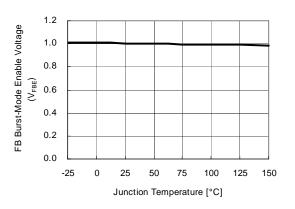
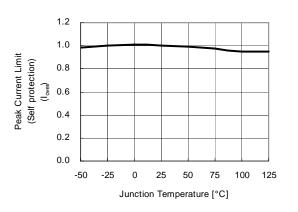
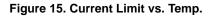
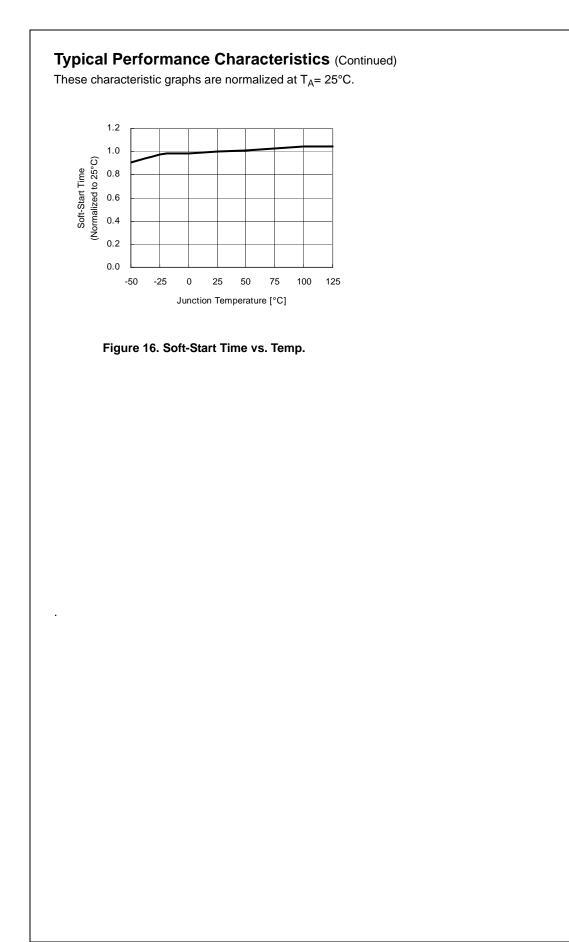


Figure 13. Burst-Mode Enable Voltage vs. Temp.





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## **Functional Description**

**1. Start-up**: In previous generations of Fairchild Power Switches (FPS<sup>TM</sup>), the V<sub>CC</sub> pin had an external start-up resistor to the DC input voltage line. In this generation, the start-up resistor is replaced by an internal high-voltage current source. At start-up, the internal high-voltage current source supplies the internal bias and charges the external capacitor (C<sub>vcc</sub>) connected to the V<sub>CC</sub> pin, as illustrated in Figure 17. When V<sub>CC</sub> reaches 12V, the FSDM0x65RE begins switching and the internal high-voltage current source is disabled. The FSDM0x65RE continues normal switching operation and the power is supplied from the auxiliary transformer winding unless V<sub>CC</sub> goes below the stop voltage of 8V.

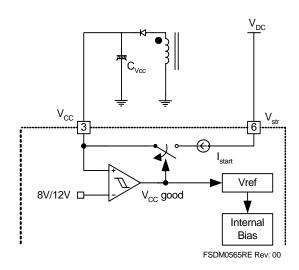


Figure 17. Internal Start-up Circuit

**2. Feedback Control**: FSDM0x65RE employs currentmode control, as shown in Figure 18. An opto-coupler (such as the H11A817A) and shunt regulator (such as the KA431) are typically used to implement the feedback network. Comparing the feedback voltage with the voltage across the  $R_{sense}$  resistor, plus an offset voltage, makes it possible to control the switching duty cycle. When the reference pin voltage of the shunt regulator exceeds the internal reference voltage of 2.5V, the optocoupler LED current increases, pulling down the feedback voltage and reducing the duty cycle. This event typically occurs when the input voltage is increased or the output load is decreased. **2.1 Pulse-by-Pulse Current Limit**: Because currentmode control is employed, the peak current through the SenseFET is limited by the inverting input of PWM comparator ( $V_{FB}^*$ ) as shown in Figure 18. Assuming that the 0.9mA current source flows only through the internal resistor (2.5R + R = 2.8k $\Omega$ ), the cathode voltage of diode D2 is about 2.5V. Since D1 is blocked when the feedback voltage ( $V_{FB}$ ) exceeds 2.5V, the maximum voltage of the cathode of D2 is clamped at this voltage, thus clamping  $V_{FB}^*$ . Therefore, the peak value of the current through the SenseFET is limited.

**2.2 Leading Edge Blanking (LEB)**: At the instant the internal SenseFET is turned on, a high-current spike occurs through the SenseFET, caused by primary-side capacitance and secondary-side rectifier reverse recovery. Excessive voltage across the R<sub>sense</sub> resistor would lead to incorrect feedback operation in the current mode PWM control. To counter this effect, the FSDM0x65RE employs a leading-edge blanking (LEB) circuit. This circuit inhibits the PWM comparator for a short time ( $t_{LEB}$ ) after the SenseFET is turned on.

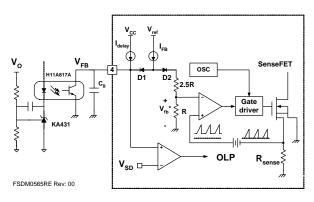


Figure 18. Pulse-Width-Modulation (PWM) Circuit

3. Protection Circuit: The FSDM0x65RE has several self-protective functions, such as overload protection (OLP), over-voltage protection (OVP), and thermal shutdown (TSD). Because these protection circuits are fully integrated into the IC without external components, the reliability is improved without increasing cost. Once a fault condition occurs, switching is terminated and the SenseFET remains off, which causes  $V_{CC}$  to fall. When V<sub>CC</sub> reaches the UVLO stop voltage of 8V, the protection is reset and the internal high-voltage current source charges the  $V_{CC}$  capacitor via the  $V_{str}$  pin. When  $V_{CC}$ reaches the UVLO start voltage of 12V, the FSDM0x65RE resumes normal operation. In this manner, the auto-restart can alternately enable and disable the switching of the power SenseFET until the fault condition is eliminated (see Figure 19).

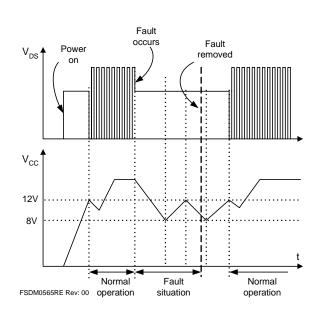


Figure 19. Auto Restart Operation

3.1 Overload Protection (OLP): Overload is defined as the load current exceeding a pre-set level due to an unexpected event. In this situation, the protection circuit should be activated to protect the SMPS. Even when the SMPS is in normal operation, the overload protection circuit can be activated during the load transition. To avoid this undesired operation, the overload protection circuit is designed to be activated after a specified time to determine whether it is a transient situation or a true overload situation. Because of the pulse-by-pulse current limit capability, the maximum peak current through the SenseFET is limited, and therefore the maximum input power is restricted with a given input voltage. If the output consumes beyond this maximum power, the output voltage (V<sub>O</sub>) decreases below the set voltage. This reduces the current through the optocoupler LED, which also reduces the opto-coupler transistor current, thus increasing the feedback voltage (V<sub>FB</sub>). If V<sub>FB</sub> exceeds 2.5V, D1 is blocked and the 3.5µA current source starts to charge C<sub>B</sub> slowly up to V<sub>CC</sub>. In this condition,  $V_{\text{FB}}$  continues increasing until it reaches 6V, when the switching operation is terminated, as shown in Figure 20. The delay time for shutdown is the time required to charge C<sub>B</sub> from 2.5V to 6.0V with 3.5µA. A 10 ~ 50ms delay time is typical for most applications.

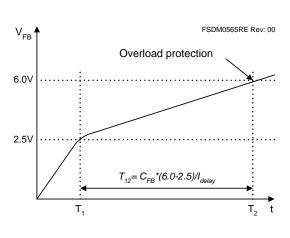


Figure 20. Overload Protection

3.2 Over-Voltage Protection (OVP): If the secondary side feedback circuit were to malfunction or a solder defect caused an opening in the feedback path, the current through the opto-coupler transistor becomes almost zero. In this event, V<sub>FB</sub> climbs in a similar manner to the overload situation, forcing the preset maximum current to be supplied to the SMPS until the overload protection is activated. Because more energy than required is provided to the output, the output voltage may exceed the rated voltage before the overload protection is activated, resulting in the breakdown of the devices in the secondary side. To prevent this situation, an overvoltage protection (OVP) circuit is employed. In general, V<sub>CC</sub> is proportional to the output voltage and the FSDM0x65RE uses V<sub>CC</sub> instead of directly monitoring the output voltage. If  $V_{CC}$  exceeds 19V, an OVP circuit is activated, resulting in the termination of the switching operation. To avoid undesired activation of OVP during normal operation, V<sub>CC</sub> should be designed below 19V.

**3.3 Thermal Shutdown (TSD)**: The SenseFET and the control IC are built in one package. This makes it easy for the control IC to detect the heat generation from the SenseFET. When the temperature exceeds ~150°C, the thermal shutdown is activated.

**4. Soft-Start**: The FSDM0x65RE has an internal softstart circuit that increases PWM comparator inverting input voltage, together with the SenseFET current, slowly after it starts up. The typical soft-start time is 10ms. The pulse width to the power switching device is progressively increased to establish the correct working conditions for transformers, inductors, and capacitors. The voltage on the output capacitors is progressively increased with the intention of smoothly establishing the required output voltage. It also helps prevent transformer saturation and reduces the stress on the secondary diode during start-up.

**5. Burst Operation**: To minimize power dissipation in standby mode, the FSDM0x65RE enters burst-mode operation. As the load decreases, the feedback voltage decreases. As shown in Figure 21, the device automatically enters burst mode when the feedback voltage drops below  $V_{BURL}(500mV)$ . At this point, switching stops and the output voltages start to drop at a rate dependent on standby current load. This causes the feedback voltage to rise. Once it passes  $V_{BURH}$  (700mV), switching resumes. The feedback voltage then falls and the process repeats. Burst-mode operation alternately enables and disables switching of the power SenseFET, thereby reducing switching loss in standby mode.

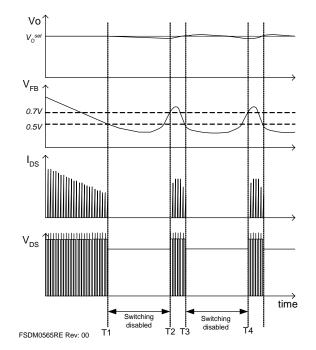


Figure 21. Waveforms of Burst Operation

## **Application Information**

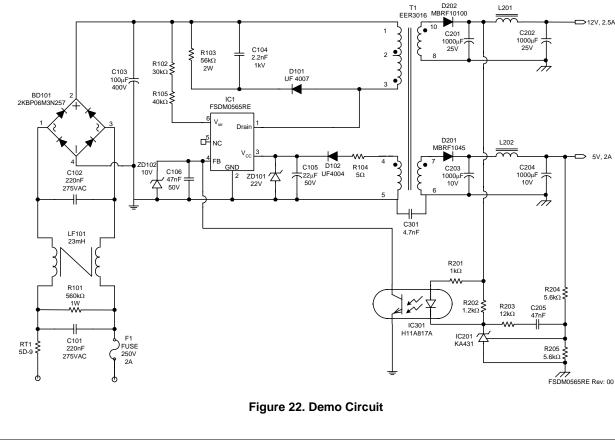
Application	Output Power	Input Voltage	Output Voltage (Max. Current)
LCD Monitor	40W	Universal input (85-265V <sub>AC</sub> )	5V (2.0A) 12V (2.5A)

#### Features

- High efficiency (>81% at 85V<sub>AC</sub> input)
- Low zero load power consumption (<300mW at 240V<sub>AC</sub> input)
- Low standby mode power consumption (<800mW at 240V<sub>AC</sub> input and 0.3W load)
- Low component count
- Enhanced system reliability through various protection functions
- Internal soft-start (10ms)

### **Key Design Notes**

- Resistors R102 and R105 are employed to prevent start-up at low input voltage. After start-up, there is no power loss in these resistors since the start-up pin is internally disconnected after start-up.
- The delay time for overload protection is designed to be about 50ms with C106 of 47nF. If a faster triggering of OLP is required, C106 can be reduced to 10nF.
- Zener diode ZD102 is used for a safety test, such as UL. When the drain pin and feedback pin are shorted, the zener diode fails and remains short, which causes the fuse (F1) to be blown and prevents explosion of the opto-coupler (IC301). This zener diode also increases the immunity against line surge.



### 1. Schematic

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### 2. Transformer

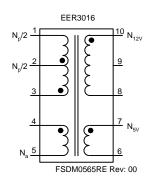


Figure 23. Transformer Schematic Diagram

### 3. Winding Specification

No	Pin (s→f)	Wire	Turns	Winding Method
N <sub>a</sub>	$4 \rightarrow 5$	$0.2^{\phi}  imes 1$	8	Center Winding
Insulation: P	Polyester Tape t = 0.050	mm, 2 Layers		
N <sub>p</sub> /2	$2 \rightarrow 1$	$0.4^{\phi}  imes$ 1	18	Solenoid Winding
Insulation: P	Polyester Tape t = 0.050	mm, 2 Layers		
N <sub>12V</sub>	$10 \rightarrow 8$	$0.3^{\varphi}\times 3$	7	Center Winding
Insulation: P	Polyester Tape t = 0.050	mm, 2 Layers		
N <sub>5V</sub>	$7 \rightarrow 6$	$0.3^{\varphi}\times 3$	3	Center Winding
Insulation: P	Polyester Tape t = 0.050	mm, 2 Layers		
N <sub>p</sub> /2	$3 \rightarrow 2$	$0.4^{\phi}  imes$ 1	18	Solenoid Winding
Outer Insula	ition: Polyester Tape t =	0.050mm, 2 Layers		

### 4. Electrical Characteristics

	Pin	Specification	Remarks
Inductance	1 - 3	520µH ± 10%	100kHz, 1V
Leakage Inductance	1 - 3	10µH Max	2 <sup>nd</sup> all short

### 5. Core & Bobbin

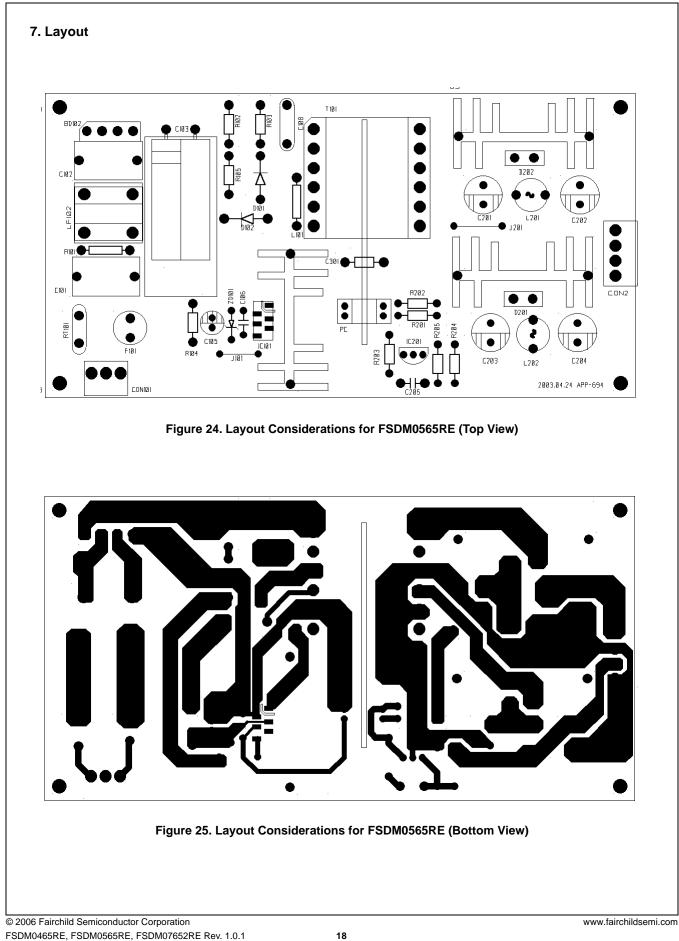
- Core: EER 3016
- Bobbin: EER3016
- Ae(mm2): 96

### 6. Demo Circuit Part List

Part	Value	Note	Part	Value	Note
	Fus	Se	D102	UF4004	
F101	2A/250V		D201	MBRF1045	
	1		D202	MBRF10100	
	NT	С	ZD101	Zener Diode	22V
RT101	5D-9		ZD102	Zener Diode	10V
	Resis	stor		Bridge	Diode
R101	560kΩ	1W	BD101	2KBP06M 3N257	Bridge Diode
R102	30kΩ	1/4W	55101		Dhage Diede
R103	56kΩ	2W		Line F	ilter
R104	5Ω	1/4W	LF101	23mH	Wire 0.4mm
R105	40kΩ	1/4W			
R201	1kΩ	1/4W		IC	:
R202	1.2kΩ	1/4W	IC101	FSDM0565RE	FPS™ (5A,650V)
R203	12kΩ	1/4W	IC201	KA431 (TL431)	Voltage reference
R204	5.6kΩ	1/4W	IC301	H11A817A	Opto-coupler
R205	5.6kΩ	1/4W			
C101	Capac 220nF/275V <sub>AC</sub>	Box Capacitor	-		
		-	_		
C102 C103	220nF/275V <sub>AC</sub> 100µF/400V	Box Capacitor Electrolytic Capacitor	_		
C103	2.2nF/1kV	Ceramic Capacitor	-		
C104	2.2/1F/1KV 22µF/50V	Electrolytic Capacitor	-		
C105	47nF/50V	Ceramic Capacitor	-		
C100	1000µF/25V	Electrolytic Capacitor	-		
C201	1000µF/25V	Electrolytic Capacitor	-		
C202	1000µF/10V	Electrolytic Capacitor	-		
C203	1000µF/10V	Electrolytic Capacitor	-		
C205	47nF/50V	Ceramic Capacitor	-		
C301	4.7nF	Polyester Film Cap.	-		
2001			-		
	Induc	ctor	_		
L201	5µH	Wire 1.2mm			
L202	5μH	Wire 1.2mm	1		
	Dio	4.0			

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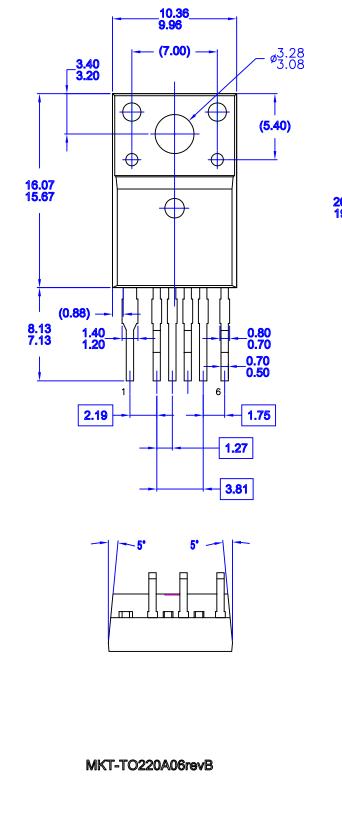
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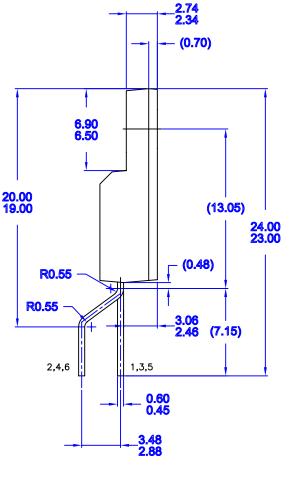


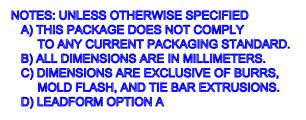
## **Package Dimensions**

### TO-220F-6L (Forming)

Dimensions are in millimeters unless otherwise noted.



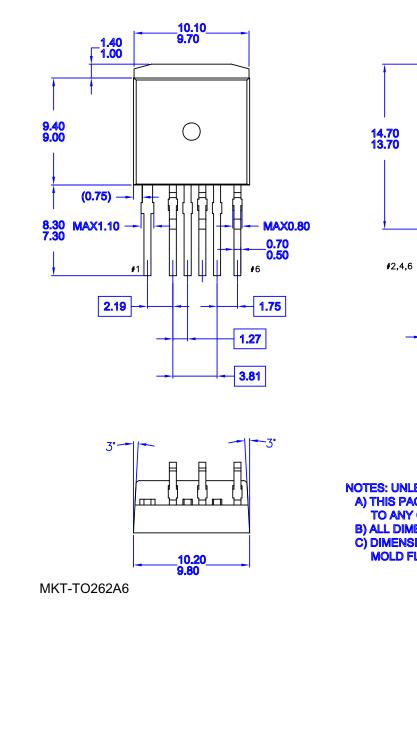


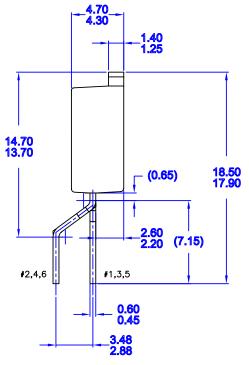


## Package Dimensions (Continued)

### I2-PAK-6L (Forming)

Dimensions are in millimeters unless otherwise noted.





NOTES: UNLESS OTHERWISE SPECIFIED A) THIS PACKAGE DOES NOT COMPLY TO ANY CURRENT PACKAGING STANDARD. B) ALL DIMENSIONS ARE IN MILLIMETERS. C) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.



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